

# **MOS FIELD EFFECT TRANSISTOR** 2SK3062

# **SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE**

### DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for high current switching applications.

# **FEATURES**

- · Low on-state resistance  $R_{DS(on)1} = 8.5 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 35 \text{ A})$  $R_{DS(on)2} = 12 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.0 \text{ V}, \text{ ID} = 35 \text{ A})$
- Low Ciss: Ciss = 5200 pF TYP.
- Built-in gate protection diode

## ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (VGs = 0 V)	VDSS	60	V
Gate to Source Voltage (VDS = 0 V)	VGSS(AC)	±20	V
Gate to Source Voltage (VDS = 0 V)	VGSS(DC)	+20, -10	V
Drain Current (DC)	D(DC)	±70	А
Drain Current (Pulse) Note1	D(pulse)	±280	А
Total Power Dissipation (Tc = 25°C)	Р⊤	100	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	Рт	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note2	las	35	А
Single Avalanche Energy Note2	Eas	122.5	mJ

#### **Notes 1.** PW $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1 %

2. Starting Tch = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0 V

#### THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	1.25	°C/W
Channel to Ambient	Rth(ch-A)	83.3	°C/W

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#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE		
2SK3062	TO-220AB		
2SK3062-S	TO-262		
2SK3062-ZJ	TO-263		

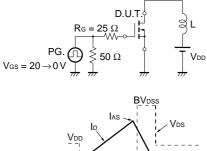
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

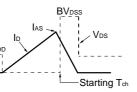
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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 35 A		6.3	8.5	mΩ
	RDS(on)2	Vgs = 4.0 V, Id = 35 A		8.2	12	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = 10 V, I_{D} = 1 mA$	1.0	1.5	2.0	V
Forward Transfer Admittance	y <sub>fs</sub>	Vds = 10 V, Id = 35 A	20	87		S
Drain Leakage Current	loss	$V_{DS} = 60 V, V_{GS} = 0 V$			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		5200		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		1300		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		480		pF
Turn-on Delay Time	td(on)	ID = 35 A		75		ns
Rise Time	tr	VGS(on) = 10 V		1150		ns
Turn-off Delay Time	td(off)	Vdd = 30 V		360		ns
Fall Time	tr	Rg = 10 Ω		480		ns
Total Gate Charge	Q <sub>G</sub>	ID = 70 A		95		nC
Gate to Source Charge	Q <sub>GS</sub>	Vdd = 48 V		13		nC
Gate to Drain Charge	Qgd	VGS(on) = 10 V		30		nC
Body Diode Forward Voltage	VF(S-D)	IF = 70 A, VGs = 0 V		0.97		V
Reverse Recovery Time	trr	IF = 70 A, VGs = 0 V		70		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		140		nC

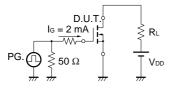
#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

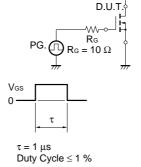
#### **TEST CIRCUIT 2 SWITCHING TIME**

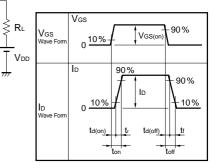




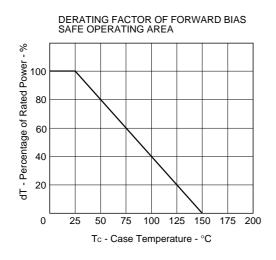
#### **TEST CIRCUIT 3 GATE CHARGE**



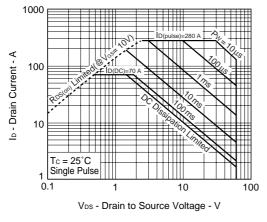




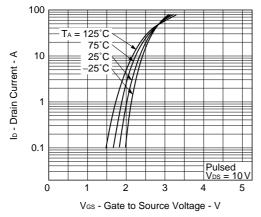
# TYPICAL CHARACTERISTICS (TA = 25 °C)

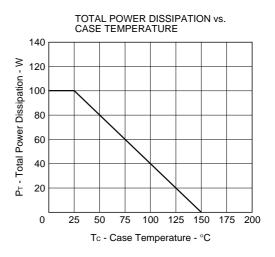


FORWARD BIAS SAFE OPERATING AREA

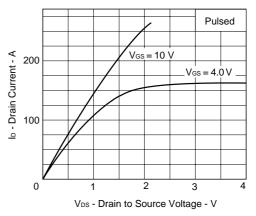






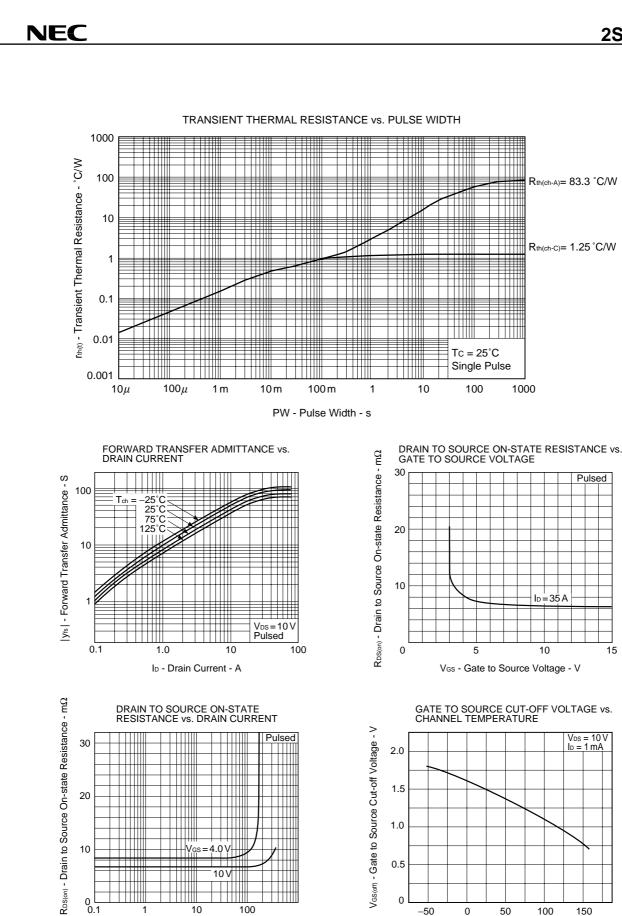




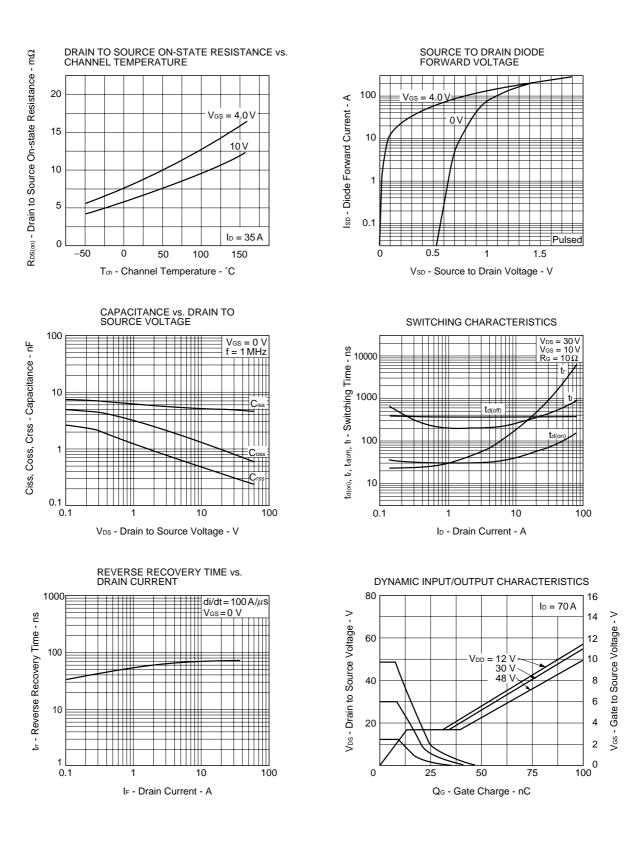


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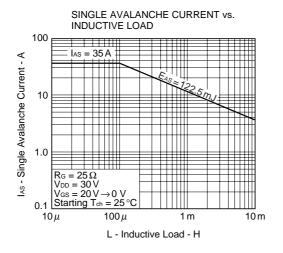
Tch - Channel Temperature - °C



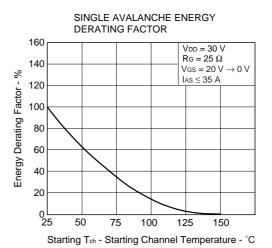
ID - Drain Current - A



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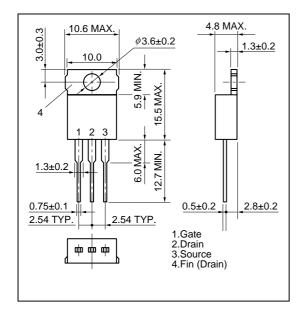
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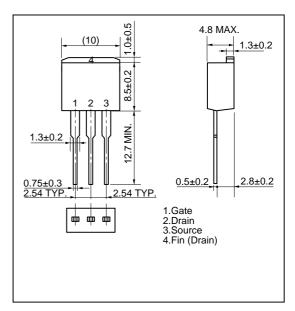
Data Sheet D13101EJ1V0DS00

# PACKAGE DRAWINGS (Unit : mm)

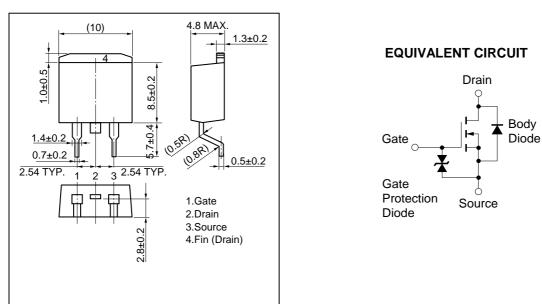
### 1)TO-220AB (MP-25)



#### 2)TO-262 (MP-25 Fin Cut)



#### 3)TO-263 (MP-25ZJ)



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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